

Highly Accurate, Ultra Small, Low Power Consumption Voltage Detector

■ GENERAL DESCRIPTION

The XC6120 series are highly precise, low power consumption voltage detectors, manufactured using CMOS and laser trimming technologies. With low power consumption and high accuracy, the series is suitable for precision mobile equipment. The XC6120 in ultra small packages are ideally suited for high-density mounting. The XC6120 is available in both CMOS and N-channel open drain output configurations.

■ APPLICATIONS

- Microprocessor reset circuitry
- Memory battery back-up circuits
- Power-on reset circuits
- Power failure detection
- System battery life and charge voltage monitors

■ FEATURES

- Highly Accurate** : $\pm 2\%$ ($V_{DF} \geq 1.5V$)
: $\pm 30mV$ ($V_{DF} < 1.5V$)
- Low Power Consumption**: $0.6 \mu A$ [$V_{DF}=2.7V, V_{IN}=2.97V$]
- Detect Voltage Range** : $1.0V \sim 5.0V$ (0.1V increments)
- Operating Voltage Range**: $0.7V \sim 6.0V$
- Detect Voltage Temperature Characteristics**
: $\pm 100ppm/^{\circ}C$ (TYP.)
- Output Configuration** : CMOS (XC6120C)
: N-channel open drain (XC6120N)
- Operating Temperature Range** : $-40^{\circ}C \sim +85^{\circ}C$
- Packages** : USP-3, SSOT-24, SOT-25
- Environmentally Friendly** : EU RoHS Compliant, Pb Free

■ TYPICAL APPLICATION CIRCUIT



■ TYPICAL PERFORMANCE CHARACTERISTICS

- Supply Current vs. Input Voltage



■ BLOCK DIAGRAMS

(1) XC6120C



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

(2) XC6120N



* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

■ PRODUCT CLASSIFICATION

1) Ordering Information

XC6120①②③④⑤⑥-⑦(*1)

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	Output Configuration	C	CMOS output
		N	N-ch open drain output
②③	Detect Voltage (V_{DF})	10~50	For example 1.0V → ②1, ③0
④	Detect Accuracy	2	$\pm 2\%$ ($1.5V \leq V_{DF} \leq 5.0V$) $\pm 30mV$ ($1.0V \leq V_{DF} \leq 1.5V$)
⑤⑥-⑦(*1)	Packages (Order Unit)	HR	USP-3 (3,000pcs/Reel)
		HR-G	USP-3 (3,000pcs/Reel)
		NR	SSOT-24 (3,000pcs/Reel)
		NR-G	SSOT-24 (3,000pcs/Reel)
		SR-G	SOT-25 (3,000pcs/Reel) Standard feed(*2)
		SL-G	SOT-25 (3,000pcs/Reel) Reverse feed(*2)

(*1) The "G" suffix indicates that the products are Halogen and Antimony free as well as being fully EU RoHS compliant.

(*2) SOT-25 uses Cu wires.

2) Taping Specifications

• SR-G



• SL-G



■ PIN CONFIGURATION



■ PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTION
USP-3	SSOT-24	SOT-25		
1	4	2	V_{IN}	Power Input
3	2	3	V_{SS}	Ground
2	3	1	V_{OUT}	Output (Detect "Low")
-	1	4,5	NC	No Connection

■ ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER		SYMBOL	RATING	UNITS
Input Voltage		V _{IN}	V _{SS} -0.3~7.0	V
Output Current		I _{OUT}	10	mA
Output Voltage	CMOS Output	V _{OUT}	V _{SS} -0.3~V _{IN} +0.3	V
	N-ch Open Drain Output		V _{SS} -0.3~7.0	
Power Dissipation	USP-3	Pd	120	mW
			1000 (40mm x 40mm Standard board) ^(*)	
	SSOT-24		150	
			500 (40mm x 40mm Standard board) ^(*)	
	SOT-25		250	
Operating Temperature Range		Topr	-40~+85	°C
Storage Temperature Range		Tstg	-55~+125	°C

^(*) The power dissipation figure shown is PCB mounted and is for reference only.
The mounting condition is please refer to PACKAGING INFORMATION.

■ ELECTRICAL CHARACTERISTICS

XC6120 Series

Ta=25°C

PARAMETER		SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNITS	CIRCUIT	
Operating Voltage		V _{IN}	V _{DF(T)} =1.0~5.0V ⁽¹⁾	0.7	-	6.0	V	-	
Detect Voltage		V _{DF}	V _{DF(T)} =1.0V~5.0V	E-1			V	①	
Hysteresis Width		V _{HYS}	V _{DF(T)} =1.0V~5.0V	V _{DF} × 0.03	V _{DF} × 0.05	V _{DF} × 0.07	V	①	
Supply Current 1		I _{SS1}	V _{IN} =V _{DF(T)} × 1.1	E-2			μA	②	
Supply Current 2		I _{SS2}	V _{IN} = V _{DF(T)} × 0.9	E-3			μA	②	
Output Current		I _{OUTN}	V _{IN} =0.7V	V _{OUT} =0.5V	0.09	0.57	-	mA	③
				V _{OUT} =0.3V	0.08	0.56	-		
				V _{OUT} =0.1V	0.05	0.30	-		
			V _{IN} =1.0V	V _{OUT} =0.1V, V _{DF(T)} > 1.0V	0.46	0.71	-		
			V _{IN} =2.0V	V _{OUT} =0.1V, V _{DF(T)} > 2.0V	1.15	1.41	-		
		V _{IN} =3.0V	V _{OUT} =0.1V, V _{DF(T)} > 3.0V	1.44	1.77	-			
	V _{IN} =4.0V	V _{OUT} =0.1V, V _{DF(T)} > 4.0V	1.61	1.96	-				
	I _{OUTP} ⁽²⁾	V _{IN} =6.0V	V _{OUT} =5.5V	-	-0.95	-0.60	mA	③	
Leakage Current	CMOS Output(Pch)	I _{LEAK}	V _{IN} =V _{DF} × 0.9, V _{OUT} =0V	-	-0.001	-	μA	③	
	N-ch Open Drain		V _{IN} =6.0V, V _{OUT} =6.0V	-	0.001	0.10			
Temperature Characteristics		ΔV _{DF} / (ΔT _{opr} · V _{DF})	-40°C ≤ T _{opr} ≤ 85°C	-	± 100	-	ppm/°C	①	
Detect Delay Time ⁽³⁾		t _{DF}	V _{IN} =6.0V→0.7V V _{IN} =V _{DF} to V _{OUT} =0.5V	-	30	100	μs	④	
Release Delay Time ⁽⁵⁾		t _{DR}	V _{IN} =0.7V→6.0V V _{IN} =V _{DR} to V _{OUT} =V _{DR} ⁽⁴⁾	-	20	100	μs	④	

⁽¹⁾: V_{DF(T)}: Nominal detect voltage

⁽²⁾: For XC6120C only.

⁽³⁾: A time taking from the time at V_{IN} = V_{DF} to the time at V_{OUT}=0.5V when V_{IN} falls from 6.0V to 0.7V.

⁽⁴⁾: V_{DR}: Release voltage (V_{DR} = V_{DF} + V_{HYS})

⁽⁵⁾: A time taking from the time at V_{IN} = V_{DR} to the time at V_{OUT} = V_{DR} when V_{IN} rise from 0.7V to 6.0V.

● XC6120N recommended pull-up resistance

Input Voltage Range	Pull-up Resistance
0.7V~6.0V	≥ 220kΩ
0.8V~6.0V	≥ 100kΩ
1.0V~6.0V	≥ 33kΩ

■ ELECTRICAL CHARACTERISTICS (Continued)

● DETECT VOLTAGE ACCURACY AND SUPPLY CURRENT SPECIFICATIONS

SYMBOL	E-1		E-2		E-3	
PARAMETER	DETECT VOLTAGE		SUPPLY CURRENT 1		SUPPLY CURRENT 2	
NOMINAL DETECT VOLTAGE	V_{DF} (V) XC6120xxx2 Series		I_{SS1} (μ A)		I_{SS2} (μ A)	
$V_{DF(T)}$	MIN.	MAX.	TYP.	MAX.	TYP.	MAX.
1.0	0.970	1.030	0.5	1.4	0.4	1.35
1.1	1.070	1.130				
1.2	1.170	1.230				
1.3	1.270	1.330				
1.4	1.370	1.430				
1.5	1.470	1.530				
1.6	1.568	1.632				
1.7	1.666	1.734				
1.8	1.764	1.836				
1.9	1.862	1.938				
2.0	1.960	2.040	0.6	1.7	0.5	1.60
2.1	2.058	2.142				
2.2	2.156	2.244				
2.3	2.254	2.346				
2.4	2.352	2.448				
2.5	2.450	2.550				
2.6	2.548	2.652				
2.7	2.646	2.754				
2.8	2.744	2.856	0.7	1.9	0.6	1.80
2.9	2.842	2.958				
3.0	2.940	3.060				
3.1	3.038	3.162				
3.2	3.136	3.264				
3.3	3.234	3.366				
3.4	3.332	3.468				
3.5	3.430	3.570				
3.6	3.528	3.672				
3.7	3.626	3.774				
3.8	3.724	3.876				
3.9	3.822	3.978				
4.0	3.920	4.080				
4.1	4.018	4.182				
4.2	4.116	4.284				
4.3	4.214	4.386				
4.4	4.312	4.488				
4.5	4.410	4.590				
4.6	4.508	4.692				
4.7	4.606	4.794				
4.8	4.704	4.896				
4.9	4.802	4.998				
5.0	4.900	5.100				

(*)When detect voltage is $1.0V \leq V_{DF(T)} < 1.5V$, detect accuracy is $\pm 30mV$.
 When detect voltage is $1.5V \leq V_{DF(T)} \leq 5.0V$, detect accuracy is $\pm 2\%$.

TEST CIRCUITS

Circuit ①



Circuit ②



Circuit ③



Circuit ④



OPERATIONAL EXPLANATION

● Typical Application Circuit



● Timing Charge



Note: For explaining in a simplified case, an operation time of the circuit is not counted.

The following explains the operation of the typical application circuit along number symbols shown in the timing chart.

- ① When input voltage (V_{IN}) is higher than detect voltage (V_{DF}), output voltage (V_{OUT}) will be equal to input voltage (V_{IN}). (A condition of high impedance exists with N-ch open drain output configurations.)
- ② When input voltage (V_{IN}) falls below detect voltage (V_{DF}), output voltage (V_{OUT}) will be equal to the ground voltage (V_{SS}) level.
- ③ When input voltage (V_{IN}) falls to a level below that of the minimum operating voltage (V_{MIN}), output will become unstable. If in this condition, V_{IN} will equal the pulled-up output (should output be pulled-up.) (Input voltage, V_{IN} , in the typical application circuit.)
- ④ When input voltage (V_{IN}) rises above the minimum operating voltage (V_{MIN}) level until it achieves a release voltage (V_{DR}), output keeps the ground voltage level (V_{SS}).
- ⑤ When the input voltage (V_{IN}) rises above the release voltage (V_{DR}), output voltage (V_{OUT}) will be equal to input voltage (V_{IN}). (A condition of high impedance exists with N-ch open drain output configurations.)
- ⑥ The difference between V_{DR} and V_{DF} represents the hysteresis width.

NOTE ON USE

1. Please use this IC within the stated maximum ratings. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
2. In order to stabilize the IC's operations, please ensure that V_{IN} pin's input frequency's rise and fall times are more than several $\mu s / V$.
3. With a resistor connected between the V_{IN} pin and the power supply V_{DD} some errors may be observed from the input voltage at the detect and release voltage. Those errors are not constant because of the fluctuation of the supply current.
4. When a resistor is connected between the V_{IN} pin and the power supply V_{DD} , oscillation may occur as a result of through current and voltage drop at the R_{IN} at the time of voltage release. (refer to the Oscillation Description (1) below) Especially in the CMOS output configurations, oscillation may occur regardless of detect/release operation if load current (I_{OUT}) exists. (refer to the Oscillation Description (2) below)
5. Please use N-ch open drains configuration, when a resistor R_{IN} is connected between the V_{IN} pin and the power supply V_{DD} power source. In such cases, please ensure that R_{IN} is less than $10k\Omega$ and that C is more than $0.1 \mu F$.
6. Torex places an importance on improving our products and its reliability.
However, by any possibility, we would request user fail-safe design and post-aging treatment on system or equipment.



[Figure 1: Circuit connected with the input resistor]

● Oscillation Description

(1) Oscillation as a result of through current

Since the XC6120 series are CMOS ICs, transient through current will flow when the IC's internal circuit switching operates regardless of output configuration. Consequently, oscillation is liable to occur as a result of the similar operations as in (1) above. This oscillation does not occur during the detect operation.

(2) Output current oscillation with the CMOS output configuration

As shown in figure 2, when the voltage applied at the power supply (V_{DD}) rises from below detect voltage to above release voltage, the IC commence release operations and the internal P-ch driver transistor will be on. The output current (I_{OUT}) flows the input resistor (R_{IN}) via the P-ch driver transistor. Because of the input resistor (R_{IN}) and the output current (I_{OUT}), an input pin voltage drops $R_{IN} \times I_{OUT}$. If the voltage drop level is larger than the IC's hysteresis width (V_{HYS}), the input pin voltage will falls below the V_{DF} and detect operations will commence so that the internal P-ch driver transistor will be off. The voltage drop will stop because the output current (I_{OUT}) which was flowing the P-ch driver transistor will run down. The input pin voltage will become the same voltage level as the input voltage (V_{IN}). For this, the input pin voltage will rise above the release voltage (V_{DR}), therefore, the release operations will begin over again. Oscillation may occur with this repetition. Further, this condition will also appear via means of a similar mechanism during detect operations.



[Figure 2: Oscillation caused by the input resistor of the CMOS output product and the output current]

TYPICAL PERFORMANCE CHARACTERISTICS

(1) Supply Current vs. Input Voltage

XC6120x102xx



XC6120x502xx



(2) Output Voltage vs. Input Voltage

XC6120C202xx



XC6120N202xx



(3) Detect Voltage, Release Voltage vs. Ambient Temperature

XC6120x102xx

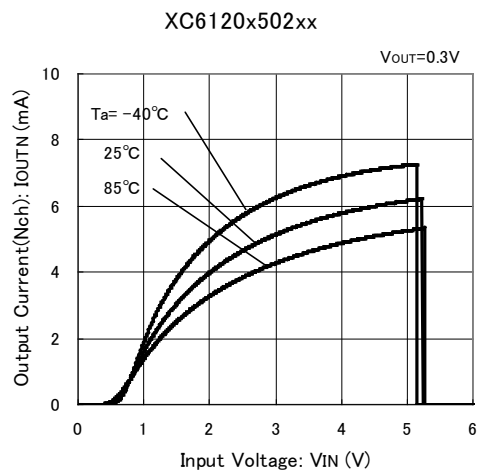


XC6120x202xx

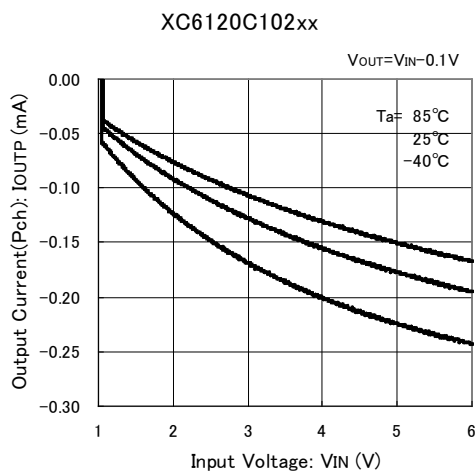
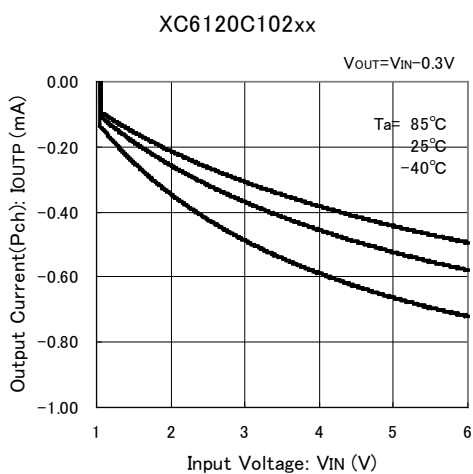
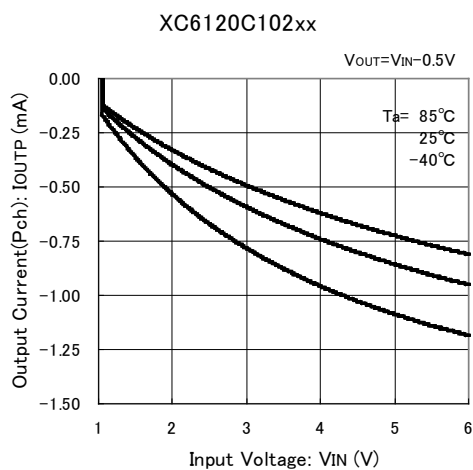


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(4) Output Current (Nch Driver) vs. Input Voltage



(5) Output Current (Pch Driver) vs. Input Voltage



■ PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

PACKAGE	OUTLINE / LAND PATTERN	THERMAL CHARACTERISTICS	
SOT-25	SOT-25 PKG	Standard Board	SOT-25 Power Dissipation
SSOT-24	SSOT-24 PKG	Standard Board	SSOT-24 Power Dissipation
USP-3	USP-3 PKG	Standard Board	USP-3 Power Dissipation

MARKING RULE

●SSOT-24



① represents output configuration and detect voltage Range

MARK	OUTPUT CONFIGURATION	OUTPUT VOLTAGE	PRODUCT SERIES
K	CMOS	1.0V~2.9V	XC6120C
L		3.0V~5.0V	
M	Nch open drain	1.0V~2.9V	XC6120N
N		3.0V~5.0V	

SSOT-24 (TOP VIEW)

② represents detect voltage

MARK	DETECT VOLTAGE (V)		MARK	DETECT VOLTAGE (V)	
0	-	3.0	F	1.5	4.5
1	-	3.1	H	1.6	4.6
2	-	3.2	K	1.7	4.7
3	-	3.3	L	1.8	4.8
4	-	3.4	M	1.9	4.9
5	-	3.5	N	2.0	5.0
6	-	3.6	P	2.1	-
7	-	3.7	R	2.2	-
8	-	3.8	S	2.3	-
9	-	3.9	T	2.4	-
A	1.0	4.0	U	2.5	-
B	1.1	4.1	V	2.6	-
C	1.2	4.2	X	2.7	-
D	1.3	4.3	Y	2.8	-
E	1.4	4.4	Z	2.9	-

③, ④ represents production lot number

01 to 09, 10, 11, ..., 99, 0A, ..., 0Z, 1A, ...repeated.

(G, I, J, O, Q, W excluded. Reversed character is not used.)

MARKING RULE (Continued)

● USP-3



USP-3
(TOP VIEW)

① represents product series

MARK	PRODUCT SERIES
0	XC6120*****

② standard : represents output configuration and integer number of detect voltage

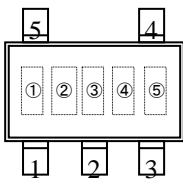
● CMOS Output (XC6120C Series)

MARK	DETECT VOLTAGE (V)
A	1.X
B	2.X
C	3.X
D	4.X
E	5.X

● Nch open drain (XC6120N Series)

MARK	DETECT VOLTAGE (V)
F	1.X
H	2.X
K	3.X
L	4.X
M	5.X

● SOT-25



SOT-25
(TOP VIEW)

③ standard : represents decimal point of detect voltage

MARK	DETECT VOLTAGE (V)	PRODUCT SERIES
3	X.3	XC6120**3***
0	X.0	XC6120**0***

④, ⑤ represents production lot number

01 to 09, 10, 11, ..., 99, 0A, ..., 0Z, 1A, ...repeated.
(G, I, J, O, Q, W excluded.)

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